

FEATURES

- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- V_{CC} Isolation Feature – If Either V_{CC} Input Is at GND, All Outputs Are in the High-Impedance State
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.65-V to 5.5-V Power-Supply Range
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

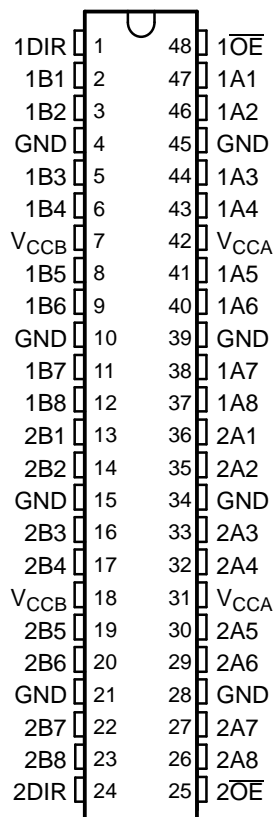
DESCRIPTION/ORDERING INFORMATION

This 16-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.

The SN74LVCH16T245 is designed so that the control pins (1DIR, 2DIR, $1\overline{OE}$, and $2\overline{OE}$) are supplied by V_{CCA} .

The SN74LVCH16T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (\overline{OE}) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ} .

DGG OR DGV PACKAGE
(TOP VIEW)



ORDERING INFORMATION

| T_A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|------------------------|---------------|-----------------------|------------------|
| –40°C to 85°C | TSSOP – DGG | Tape and reel | SN74LVCH16T245DGGR | LVCH16T245 |
| | TVSOP – DGV | Tape and reel | SN74LVCH16T245DGVR | LDHT245 |
| | VFBGA – GQL | Tape and reel | SN74LVCH16T245GQLR | LDHT245 |
| | VFBGA – ZQL (Pb-free) | Tape and reel | SN74LVCH16T245ZQLR | |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SN74LVCH16T245
16-BIT DUAL-SUPPLY BUS TRANSCEIVER
WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES635A–JULY 2005–REVISED AUGUST 2005

DESCRIPTION/ORDERING INFORMATION (CONTINUED)

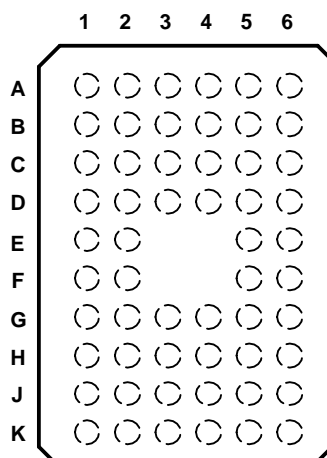
Active bus-hold circuitry holds unused or undriven data inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then all outputs are in the high-impedance state. The bus-hold circuitry on the powered-up side always stays active.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

GQL OR ZQL PACKAGE
(TOP VIEW)



TERMINAL ASSIGNMENTS⁽¹⁾

| | 1 | 2 | 3 | 4 | 5 | 6 |
|----------|------|-----|-----------|-----------|-----|-------------------|
| A | 1DIR | NC | NC | NC | NC | 1 \overline{OE} |
| B | 1B2 | 1B1 | GND | GND | 1A1 | 1A2 |
| C | 1B4 | 1B3 | V_{CCB} | V_{CCA} | 1A3 | 1A4 |
| D | 1B6 | 1B5 | GND | GND | 1A5 | 1A6 |
| E | 1B8 | 1B7 | | | 1A7 | 1A8 |
| F | 2B1 | 2B2 | | | 2A2 | 2A1 |
| G | 2B3 | 2B4 | GND | GND | 2A4 | 2A3 |
| H | 2B5 | 2B6 | V_{CCB} | V_{CCA} | 2A6 | 2A5 |
| J | 2B7 | 2B8 | GND | GND | 2A8 | 2A7 |
| K | 2DIR | NC | NC | NC | NC | 2 \overline{OE} |

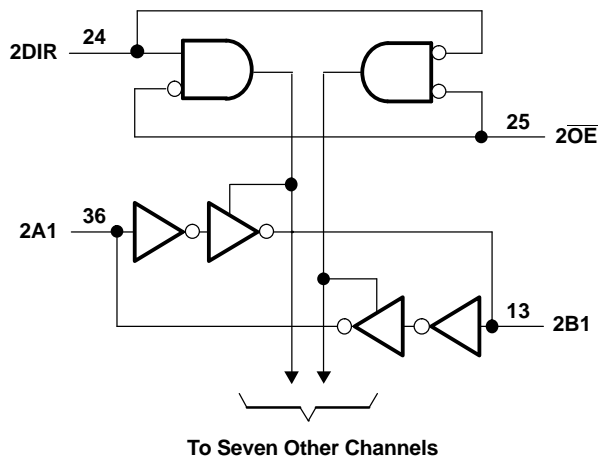
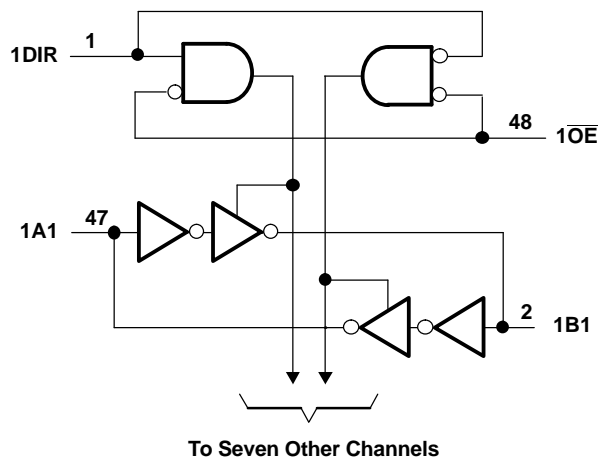
(1) NC – No internal connection

FUNCTION TABLE⁽¹⁾
(EACH 16-BIT SECTION)

| CONTROL INPUTS | | OUTPUT CIRCUITS | | OPERATION |
|-----------------|-----|-----------------|---------|-----------------|
| \overline{OE} | DIR | A PORT | B PORT | |
| L | L | Enabled | Hi-Z | B data to A bus |
| L | H | Hi-Z | Enabled | A data to B bus |
| H | X | Hi-Z | Hi-Z | Isolation |

(1) Input circuits of the data I/Os are always active.

LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|---|---|--------------------|------|-----------------|------|
| V_{CCA} V_{CCB} | Supply voltage range | | -0.5 | 6.5 | V |
| V_I | Input voltage range ⁽²⁾ | I/O ports (A port) | -0.5 | 6.5 | V |
| | | I/O ports (B port) | -0.5 | 6.5 | |
| | | Control inputs | -0.5 | 6.5 | |
| V_O | Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾ | A port | -0.5 | 6.5 | V |
| | | B port | -0.5 | 6.5 | |
| V_O | Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾ | A port | -0.5 | $V_{CCA} + 0.5$ | V |
| | | B port | -0.5 | $V_{CCB} + 0.5$ | |
| I_{IK} | Input clamp current | $V_I < 0$ | -50 | | mA |
| I_{OK} | Output clamp current | $V_O < 0$ | -50 | | mA |
| I_O | Continuous output current | | ±50 | | mA |
| Continuous current through each V_{CCA} , V_{CCB} , and GND | | | ±100 | | mA |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | DGG package | 70 | | °C/W |
| | | DGV package | 58 | | |
| | | GQL/ZQL package | 28 | | |
| T_{stg} | Storage temperature range | | -65 | 150 | °C |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The output positive-voltage rating may be exceeded up to 6.5 V maximum if the output current rating is observed.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

SN74LVCH16T245

16-BIT DUAL-SUPPLY BUS TRANSCEIVER

WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES635A–JULY 2005–REVISED AUGUST 2005

Recommended Operating Conditions⁽¹⁾⁽²⁾⁽³⁾

| | | | V _{CCI} | V _{CCO} | MIN | MAX | UNIT |
|------------------|------------------------------------|---|------------------|------------------|-------------------------|------------------|------|
| V _{CCA} | Supply voltage | | | | 1.65 | 5.5 | V |
| V _{CCB} | | | | | 1.65 | 5.5 | |
| V _{IH} | High-level input voltage | Data inputs ⁽⁴⁾ | 1.65 V to 1.95 V | | V _{CCI} × 0.65 | | V |
| | | | 2.3 V to 2.7 V | | 1.7 | | |
| | | | 3 V to 3.6 V | | 2 | | |
| | | | 4.5 V to 5.5 V | | V _{CCI} × 0.7 | | |
| V _{IL} | Low-level input voltage | Data inputs ⁽⁴⁾ | 1.65 V to 1.95 V | | V _{CCI} × 0.35 | | V |
| | | | 2.3 V to 2.7 V | | 0.7 | | |
| | | | 3 V to 3.6 V | | 0.8 | | |
| | | | 4.5 V to 5.5 V | | V _{CCI} × 0.3 | | |
| V _{IH} | High-level input voltage | Control inputs (referenced to V _{CCA}) ⁽⁵⁾ | 1.65 V to 1.95 V | | V _{CCA} × 0.65 | | V |
| | | | 2.3 V to 2.7 V | | 1.7 | | |
| | | | 3 V to 3.6 V | | 2 | | |
| | | | 4.5 V to 5.5 V | | V _{CCA} × 0.7 | | |
| V _{IL} | Low-level input voltage | Control inputs (referenced to V _{CCA}) ⁽⁵⁾ | 1.65 V to 1.95 V | | V _{CCA} × 0.35 | | V |
| | | | 2.3 V to 2.7 V | | 0.7 | | |
| | | | 3 V to 3.6 V | | 0.8 | | |
| | | | 4.5 V to 5.5 V | | V _{CCA} × 0.3 | | |
| V _I | Input voltage | Control inputs | | | 0 | 5.5 | V |
| V _{I/O} | Input/output voltage | Active state | | | 0 | V _{CCO} | V |
| | | 3-State | | | 0 | 5.5 | |
| I _{OH} | High-level output current | | | 1.65 V to 1.95 V | | −4 | mA |
| | | | | 2.3 V to 2.7 V | | −8 | |
| | | | | 3 V to 3.6 V | | −24 | |
| | | | | 4.5 V to 5.5 V | | −32 | |
| I _{OL} | Low-level output current | | | 1.65 V to 1.95 V | | 4 | mA |
| | | | | 2.3 V to 2.7 V | | 8 | |
| | | | | 3 V to 3.6 V | | 24 | |
| | | | | 4.5 V to 5.5 V | | 32 | |
| Δt/Δv | Input transition rise or fall rate | Data inputs | 1.65 V to 1.95 V | | | 20 | ns/V |
| | | | 2.3 V to 2.7 V | | | 20 | |
| | | | 3 V to 3.6 V | | | 10 | |
| | | | 4.5 V to 5.5 V | | | 5 | |
| T _A | Operating free-air temperature | | | | −40 | 85 | °C |

(1) V_{CCI} is the V_{CC} associated with the data input port.

(2) V_{CCO} is the V_{CC} associated with the output port.

(3) All unused control inputs of the device must be held at V_{CCA} GND to ensure proper device operation and minimize power consumption. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

(4) For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V.

(5) For V_{CCA} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.

Electrical Characteristics⁽¹⁾⁽²⁾

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | V _{CCA} | V _{CCB} | MIN | TYP | MAX | MIN | MAX | UNIT |
|-------------------------------------|--|---|----------------------|------------------|------------------|-----|------|-----|------------------------|------|------|
| V _{OH} | I _{OH} = −100 μA, V _I = V _{IH} | | | 1.65 V to 4.5 V | 1.65 V to 4.5 V | | | | V _{CCO} − 0.1 | | V |
| | I _{OH} = −4 mA, V _I = V _{IH} | | | 1.65 V | 1.65 V | | | | 1.2 | | |
| | I _{OH} = −8 mA, V _I = V _{IH} | | | 2.3 V | 2.3 V | | | | 1.9 | | |
| | I _{OH} = −24 mA, V _I = V _{IH} | | | 3 V | 3 V | | | | 2.4 | | |
| | I _{OH} = −32 mA, V _I = V _{IH} | | | 4.5 V | 4.5 V | | | | 3.8 | | |
| V _{OL} | I _{OL} = 100 μA, V _I = V _{IL} | | | 1.65 V to 4.5 V | 1.65 V to 4.5 V | | | | | 0.1 | V |
| | I _{OL} = 4 mA, V _I = V _{IL} | | | 1.65 V | 1.65 V | | | | | 0.45 | |
| | I _{OL} = 8 mA, V _I = V _{IL} | | | 2.3 V | 2.3 V | | | | | 0.3 | |
| | I _{OL} = 24 mA, V _I = V _{IL} | | | 3 V | 3 V | | | | | 0.55 | |
| | I _{OL} = 32 mA, V _I = V _{IL} | | | 4.5 V | 4.5 V | | | | | 0.55 | |
| I _I | Control inputs | V _I = V _{CCA} or GND | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | ±0.5 | ±1 | | ±2 | μA |
| I _{BHL} ⁽³⁾ | V _I = 0.58 V | | | 1.65 V | 1.65 V | | | | | 15 | μA |
| | V _I = 0.7 V | | | 2.3 V | 2.3 V | | | | | 45 | |
| | V _I = 0.8 V | | | 3 V | 3 V | | | | | 75 | |
| | V _I = 0.1.35 V | | | 4.5 V | 4.5 V | | | | | 100 | |
| I _{BHH} ⁽⁴⁾ | V _I = 1.07 V | | | 1.65 V | 1.65 V | | | | | −15 | μA |
| | V _I = 1.7 V | | | 2.3 V | 2.3 V | | | | | −45 | |
| | V _I = 2 V | | | 3 V | 3 V | | | | | −75 | |
| | V _I = 3.15 V | | | 4.5 V | 4.5 V | | | | | −100 | |
| I _{BHLO} ⁽⁵⁾ | V _I = 0 to V _{CC} | | | 1.95 V | 1.95 V | | | | | 200 | μA |
| | | | | 2.7 V | 2.7 V | | | | 300 | | |
| | | | | 3.6 V | 3.6 V | | | | 500 | | |
| | | | | 5.5 V | 5.5 V | | | | 900 | | |
| I _{BHHO} ⁽⁶⁾ | V _I = 0 to V _{CC} | | | 1.95 V | 1.95 V | | | | | −200 | μA |
| | | | | 2.7 V | 2.7 V | | | | −300 | | |
| | | | | 3.6 V | 3.6 V | | | | −500 | | |
| | | | | 5.5 V | 5.5 V | | | | −900 | | |
| I _{off} | A port | V _I or V _O = 0 to 5.5 V | | 0 V | 0 to 5.5 V | | ±0.5 | ±1 | | ±2 | μA |
| | B port | | | 0 to 5.5 V | 0 V | | ±0.5 | ±1 | | ±2 | |
| I _{OZ} | A or B port | V _O = V _{CCO} or GND, V _I = V _{CCI} or GND | OE = V _{IH} | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | ±1 | | ±2 | μA |
| | B port | | OE = don't care | 0 V | 5.5 V | | | ±1 | | ±2 | |
| | A port | | OE = don't care | 5.5 V | 0 V | | | ±1 | | ±2 | |
| I _{CCA} | V _I = V _{CCI} or GND, I _O = 0 | | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | | | 20 | μA |
| | | | | 5 V | 0 V | | | | 20 | | |
| | | | | 0 V | 5 V | | | | −2 | | |
| I _{CCB} | V _I = V _{CCB} or GND, I _O = 0 | | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | | | 20 | μA |
| | | | | 5 V | 0 V | | | | −2 | | |
| | | | | 0 V | 5 V | | | | 20 | | |
| I _{CCA} + I _{CCB} | | V _I = V _{CCI} or GND, I _O = 0 | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | | | 30 | μA |

(1) V_{CCO} is the V_{CC} associated with the output port.

(2) V_{CCI} is the V_{CC} associated with the input port.

(3) The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

(4) The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.

(5) An external driver must source at least I_{BHLO} to switch this node from low to high.

(6) An external driver must sink at least I_{BHHO} to switch this node from high to low.

SN74LVCH16T245

16-BIT DUAL-SUPPLY BUS TRANSCEIVER

WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

SCES635A—JULY 2005—REVISED AUGUST 2005

Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | V_{CCA} | V_{CCB} | MIN | TYP | MAX | MIN | MAX | UNIT |
|------------------|----------------|---|--------------|--------------|-----|-----|-----|-----|-----|---------|
| ΔI_{CCA} | DIR | DIR at $V_{CCA} - 0.6$ V, B port = open, A port at V_{CCA} or GND | 3 V to 5.5 V | 3 V to 5.5 V | | | | | 50 | μ A |
| C_i | Control inputs | $V_i = V_{CCA}$ or GND | 3.3 V | 3.3 V | | 4 | | | 5 | pF |
| C_{io} | A or B port | $V_O = V_{CCA/B}$ or GND | 3.3 V | 3.3 V | | 8.5 | | | 10 | pF |

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.8$ V \pm 0.15 V (unless otherwise noted) (see [Figure 1](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.8$ V ± 0.15 V | | $V_{CCB} = 2.5$ V ± 0.2 V | | $V_{CCB} = 3.3$ V ± 0.3 V | | $V_{CCB} = 5$ V ± 0.5 V | | UNIT |
|-----------|-----------------|-------------|-----------------------------------|------|----------------------------------|------|----------------------------------|------|--------------------------------|------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A | B | 1.7 | 21.9 | 1.3 | 9.2 | 1 | 7.4 | 0.4 | 7.1 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PLH} | B | A | 0.9 | 23.8 | 0.8 | 23.8 | 0.7 | 23.4 | 0.7 | 23.4 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | A | 1.5 | 29.6 | 1.5 | 29.4 | 1.5 | 29.3 | 1.4 | 29.2 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | B | 2.4 | 32.2 | 1.9 | 13.1 | 1.7 | 12 | 1.3 | 10.3 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | A | 0.4 | 24 | 0.4 | 23.8 | 0.4 | 23.7 | 0.4 | 23.7 | ns |
| t_{PZL} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | B | 1.8 | 32 | 1.5 | 18 | 1.2 | 12.6 | 0.9 | 10.8 | ns |
| t_{PZL} | | | | | | | | | | | |

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 2.5$ V \pm 0.2 V (unless otherwise noted) (see [Figure 1](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.8$ V ± 0.15 V | | $V_{CCB} = 2.5$ V ± 0.2 V | | $V_{CCB} = 3.3$ V ± 0.3 V | | $V_{CCB} = 5$ V ± 0.5 V | | UNIT |
|-----------|-----------------|-------------|-----------------------------------|------|----------------------------------|------|----------------------------------|------|--------------------------------|------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A | B | 1.5 | 21.4 | 1.2 | 9 | 0.8 | 6.2 | 0.6 | 4.8 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PLH} | B | A | 1.2 | 9.3 | 1 | 9.1 | 1 | 8.9 | 0.9 | 8.8 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | A | 1.4 | 9 | 1.4 | 9 | 1.4 | 9 | 1.4 | 9 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | B | 2.3 | 29.6 | 1.8 | 11 | 1.7 | 9.3 | 0.9 | 6.9 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | A | 1 | 10.9 | 1 | 10.9 | 1 | 10.9 | 1 | 10.9 | ns |
| t_{PZL} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | B | 1.7 | 28.2 | 1.5 | 12.9 | 1.2 | 9.4 | 1 | 6.9 | ns |
| t_{PZL} | | | | | | | | | | | |

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see [Figure 1](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CCB} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | | $V_{CCB} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | | $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | | $V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$ | | UNIT |
|-----------|-----------------|----------------|--|------|---|------|---|-----|---|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A | B | 1.6 | 21.2 | 1.1 | 8.8 | 0.8 | 6.2 | 0.6 | 4.4 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PLH} | B | A | 0.8 | 7.2 | 0.8 | 6.2 | 0.7 | 6.1 | 0.6 | 6 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | A | 1.6 | 8.2 | 1.6 | 8.2 | 1.6 | 8.2 | 1.6 | 8.2 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | B | 2.1 | 29 | 1.7 | 10.3 | 1.5 | 8.8 | 0.8 | 6.3 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | A | 0.8 | 7.8 | 0.8 | 8.1 | 0.8 | 8.1 | 0.8 | 8.1 | ns |
| t_{PZL} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | B | 1.8 | 27.7 | 1.4 | 12.4 | 1.1 | 8.5 | 0.8 | 6.4 | ns |
| t_{PZL} | | | | | | | | | | | |

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 5 \text{ V} \pm 0.5 \text{ V}$ (unless otherwise noted) (see [Figure 1](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$ | | $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$ | | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | | $V_{CC} = 5 \text{ V} \pm 0.5 \text{ V}$ | | UNIT |
|-----------|-----------------|----------------|---|------|--|------|--|-----|--|-----|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t_{PLH} | A | B | 1.5 | 21.4 | 1 | 8.8 | 0.7 | 6 | 0.4 | 4.2 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PLH} | B | A | 0.7 | 7 | 0.4 | 4.8 | 0.3 | 4.5 | 0.3 | 4.3 | ns |
| t_{PHL} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | A | 0.3 | 5.4 | 0.3 | 5.4 | 0.3 | 5.4 | 0.3 | 5.4 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PHZ} | \overline{OE} | B | 2 | 28.7 | 1.8 | 9.7 | 1.4 | 8 | 0.7 | 5.7 | ns |
| t_{PLZ} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | A | 0.7 | 6.4 | 0.7 | 6.4 | 0.7 | 6.4 | 0.7 | 6.4 | ns |
| t_{PZL} | | | | | | | | | | | |
| t_{PZH} | \overline{OE} | B | 1.5 | 27.6 | 1.3 | 11.4 | 1 | 8.1 | 0.9 | 6 | ns |
| t_{PZL} | | | | | | | | | | | |

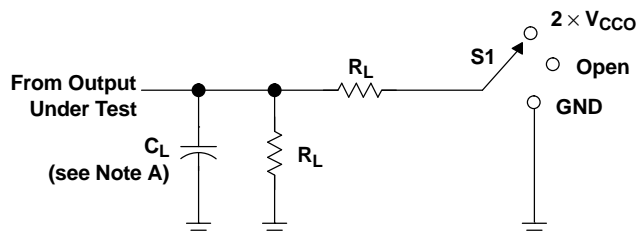
Operating Characteristics

$T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | $V_{CCA} =$ $V_{CCB} = 1.8 \text{ V}$ | $V_{CCA} =$ $V_{CCB} = 2.5 \text{ V}$ | $V_{CCA} =$ $V_{CCB} = 3.3 \text{ V}$ | $V_{CCA} =$ $V_{CCB} = 5 \text{ V}$ | UNIT |
|-----------------|-----------------------------|---|--|--|--|--|------|
| | | | TYP | TYP | TYP | TYP | |
| $C_{pdA}^{(1)}$ | A-port input, B-port output | $C_L = 0,$ $f = 10 \text{ MHz},$ $t_r = t_f = 1 \text{ ns}$ | 2 | 2 | 2 | 3 | pF |
| | B-port input, A-port output | | 18 | 19 | 19 | 22 | |
| $C_{pdB}^{(1)}$ | A-port input, B-port output | | 18 | 19 | 20 | 22 | |
| | B-port input, A-port output | | 2 | 2 | 2 | 2 | |

(1) Power dissipation capacitance per transceiver

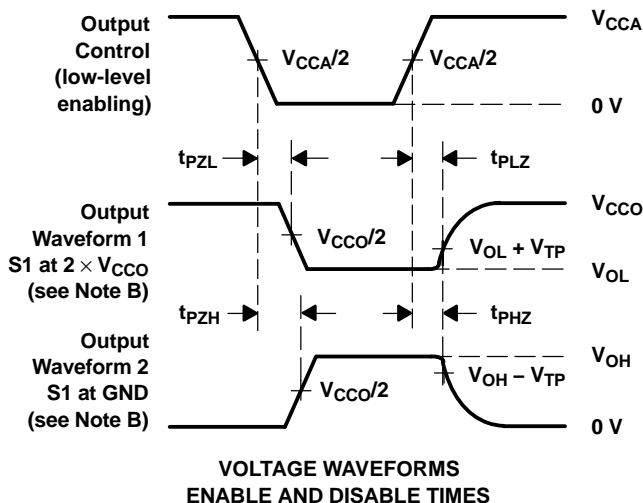
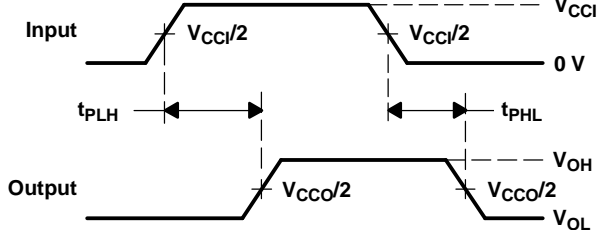
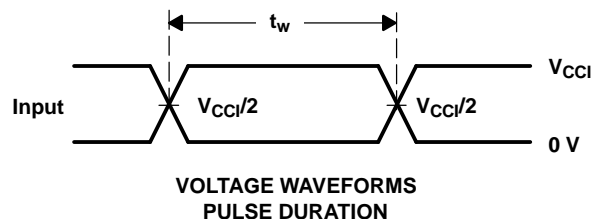
PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

| V_{CCO} | C_L | R_L | V_{TP} |
|------------------------------------|-------|--------------|----------|
| $1.8 \text{ V} \pm 0.15 \text{ V}$ | 15 pF | 2 k Ω | 0.15 V |
| $2.5 \text{ V} \pm 0.2 \text{ V}$ | 15 pF | 2 k Ω | 0.15 V |
| $3.3 \text{ V} \pm 0.3 \text{ V}$ | 15 pF | 2 k Ω | 0.3 V |
| $5 \text{ V} \pm 0.5 \text{ V}$ | 15 pF | 2 k Ω | 0.3 V |

| TEST | S1 |
|-------------------|--------------------|
| t_{pd} | Open |
| t_{PLZ}/t_{PZL} | $2 \times V_{CCO}$ |
| t_{PHZ}/t_{PZH} | GND |



- NOTES: A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $dv/dt \geq 1 \text{ V/ns}$, $dv/dt \geq 1 \text{ V/ns}$.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.
- J. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|--------------------|-----------------------|-------------------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 74LVCH16T245DGGRE4 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74LVCH16T245DGGRG4 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74LVCH16T245DGVRG4 | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74LVCH16T245DLG4 | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74LVCH16T245DLRG4 | ACTIVE | SSOP | DL | 48 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74LVCH16T245ZQLR | ACTIVE | BGA MICROSTAR JUNIOR OR | ZQL | 56 | 1000 | Green (RoHS & no Sb/Br) | SNAGCU | Level-1-260C-UNLIM |
| SN74LVCH16T245DGGR | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCH16T245DGVR | ACTIVE | TVSOP | DGV | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCH16T245DL | ACTIVE | SSOP | DL | 48 | 25 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCH16T245DLR | ACTIVE | SSOP | DL | 48 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVCH16T245KR | NRND | BGA MICROSTAR JUNIOR OR | GQL | 56 | 1000 | TBD | SNPB | Level-1-240C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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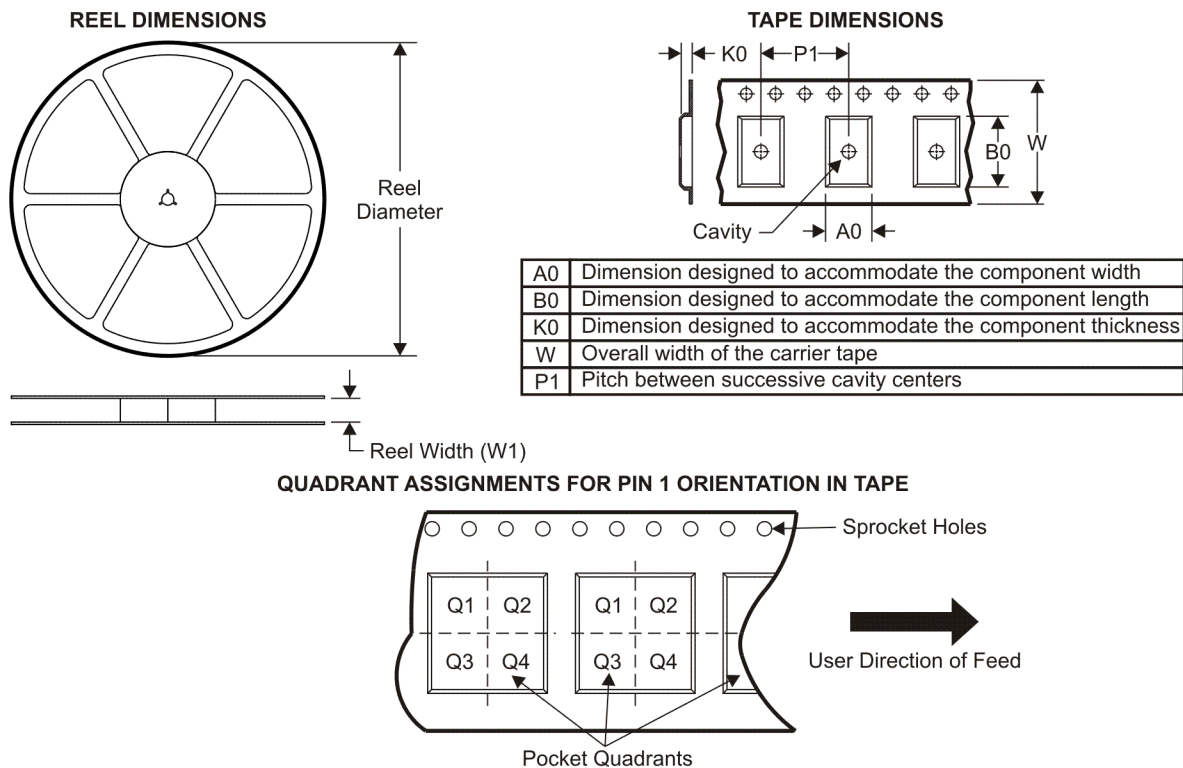
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OTHER QUALIFIED VERSIONS OF SN74LVCH16T245 :

- Enhanced Product: [SN74LVCH16T245-EP](#)

NOTE: Qualified Version Definitions:

- Enhanced Product - Supports Defense, Aerospace and Medical Applications

TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|----------------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| 74LVCH16T245ZQLR | BGA MICROSTAR JUNIOR | ZQL | 56 | 1000 | 330.0 | 16.4 | 4.8 | 7.3 | 1.5 | 8.0 | 16.0 | Q1 |
| SN74LVCH16T245DGGR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 15.8 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74LVCH16T245DGVR | TVSOP | DGV | 48 | 2000 | 330.0 | 16.4 | 7.1 | 10.2 | 1.6 | 12.0 | 16.0 | Q1 |
| SN74LVCH16T245DLR | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |
| SN74LVCH16T245KR | BGA MICROSTAR JUNIOR | GQL | 56 | 1000 | 330.0 | 16.4 | 4.8 | 7.3 | 1.5 | 8.0 | 16.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS

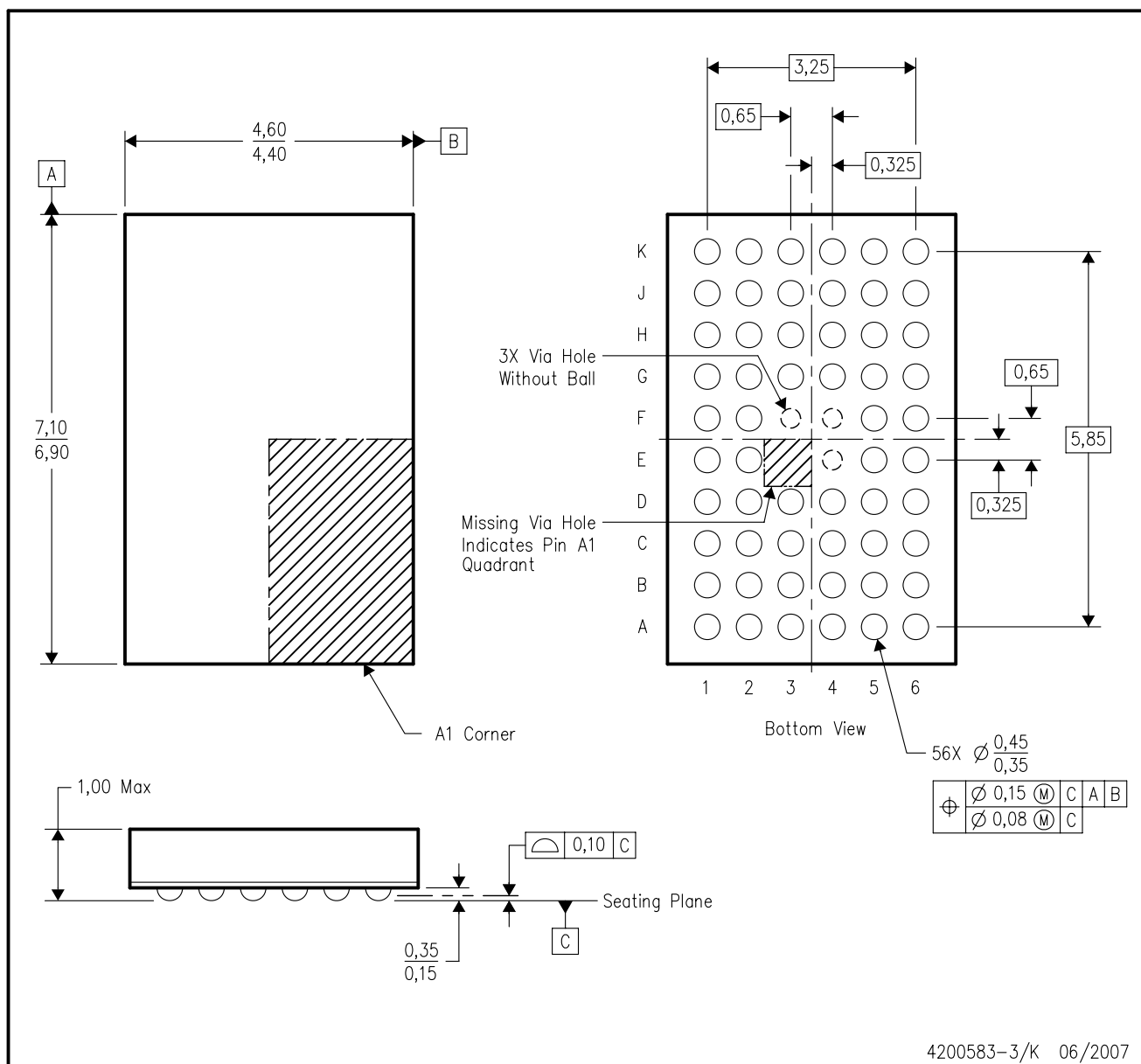


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------------|----------------------|-----------------|------|------|-------------|------------|-------------|
| 74LVCH16T245ZQLR | BGA MICROSTAR JUNIOR | ZQL | 56 | 1000 | 333.2 | 345.9 | 28.6 |
| SN74LVCH16T245DGGR | TSSOP | DGG | 48 | 2000 | 346.0 | 346.0 | 41.0 |
| SN74LVCH16T245DGVR | TVSOP | DGV | 48 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74LVCH16T245DLR | SSOP | DL | 48 | 1000 | 346.0 | 346.0 | 49.0 |
| SN74LVCH16T245KR | BGA MICROSTAR JUNIOR | GQL | 56 | 1000 | 333.2 | 345.9 | 28.6 |

GQL (R-PBGA-N56)

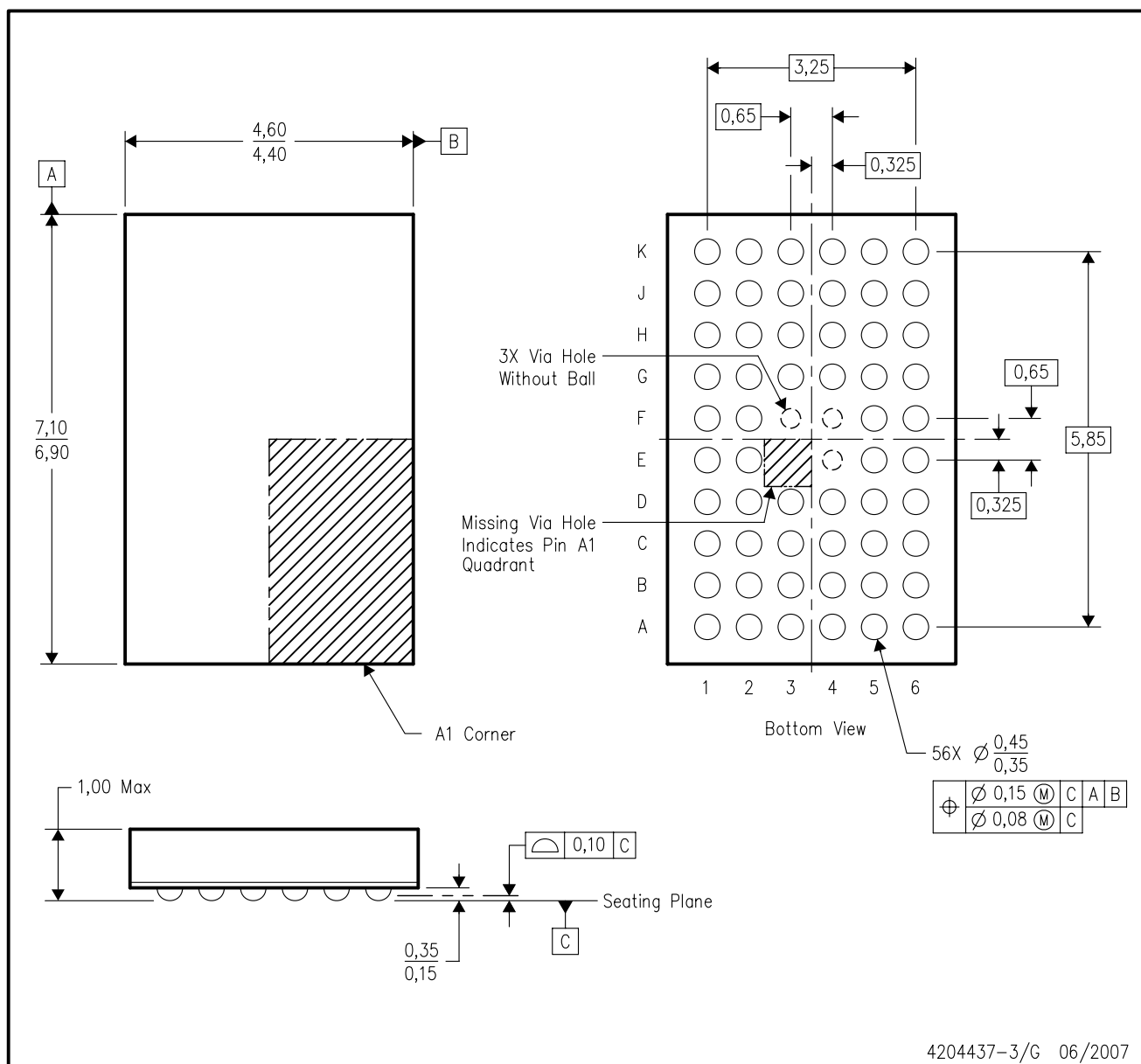
PLASTIC BALL GRID ARRAY



- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-285 variation BA-2.
 - This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY

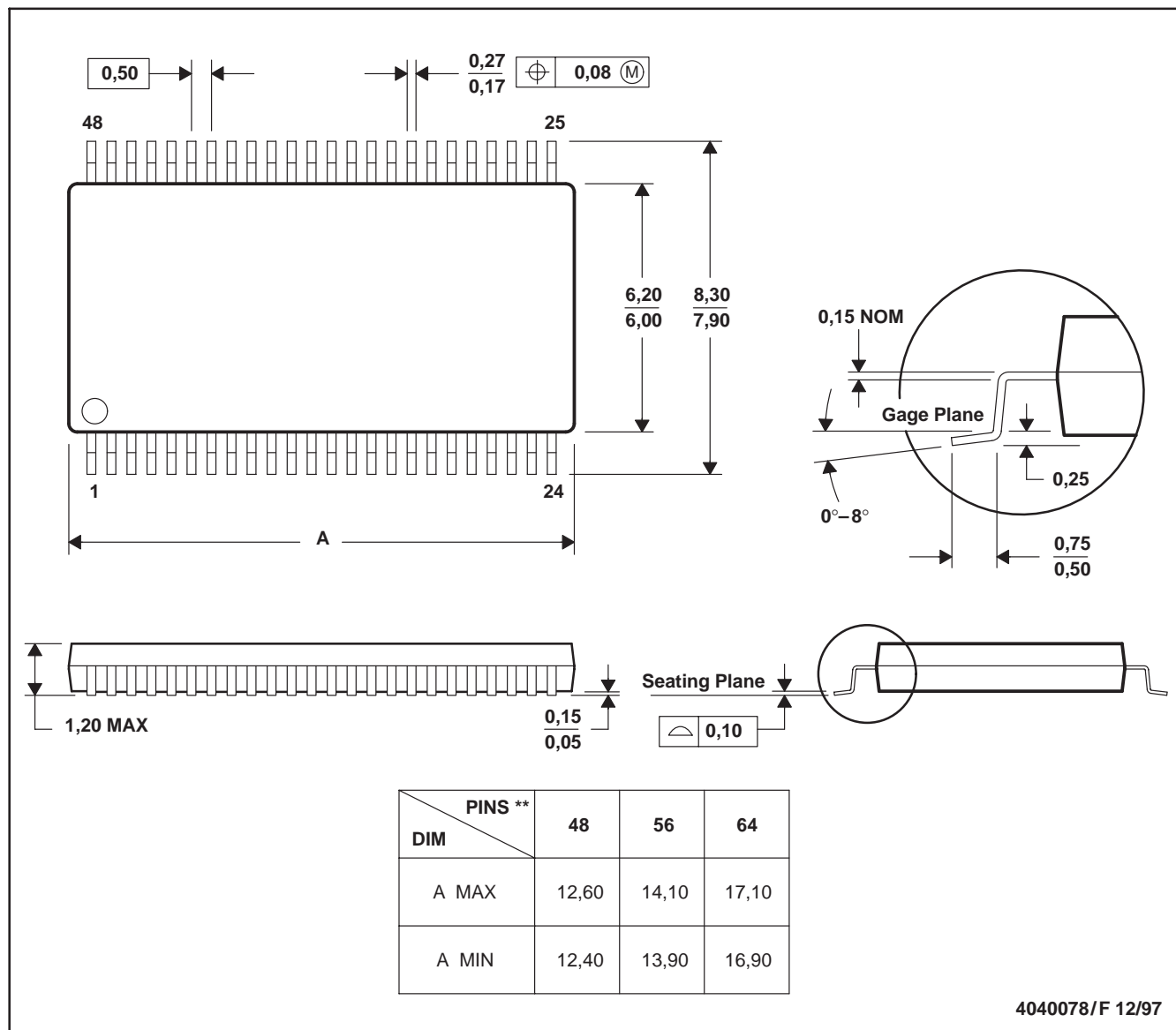


- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - Falls within JEDEC MO-285 variation BA-2.
 - This package is lead-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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